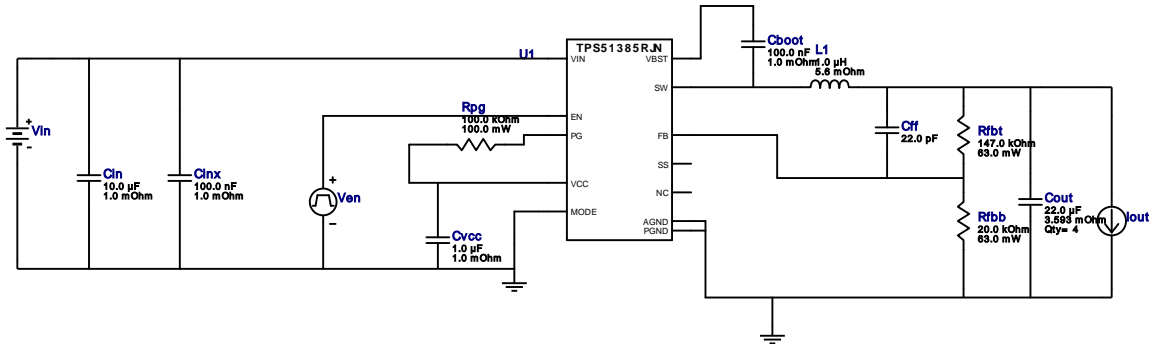


WEBENCH® Design Report

Design : 8 TPS51385RJNR
TPS51385RJNR 10V-22V to 5.00V @ 5A

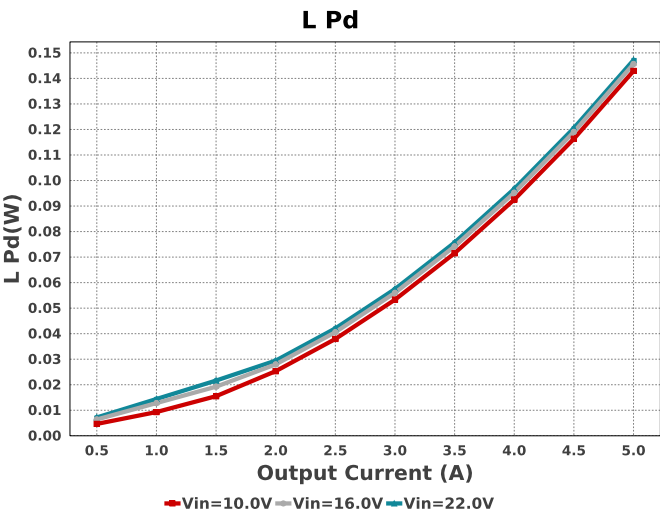
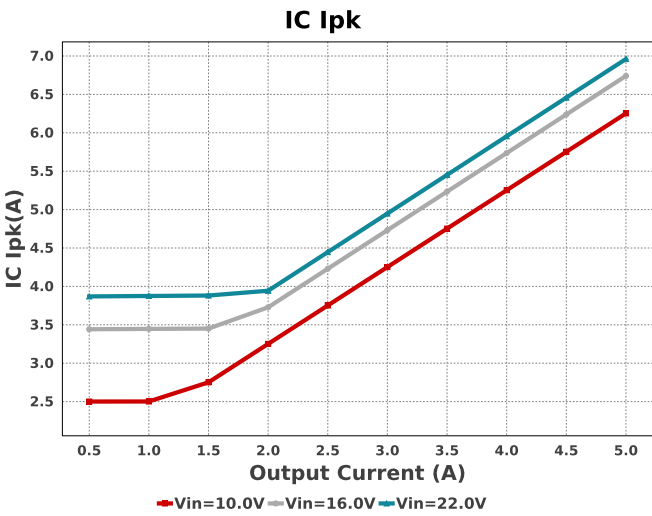
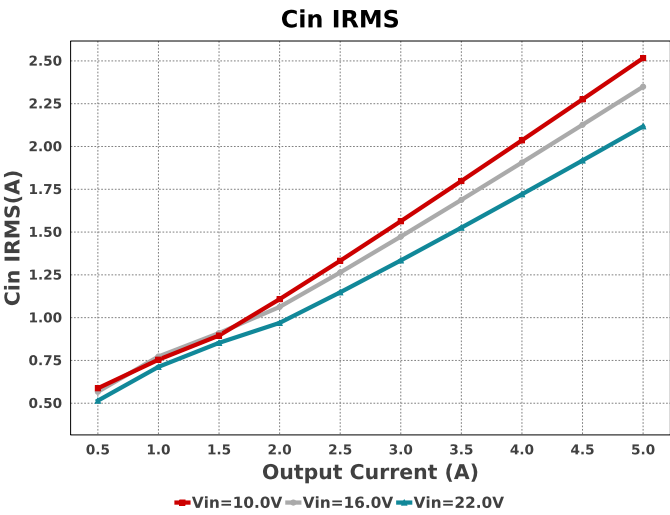
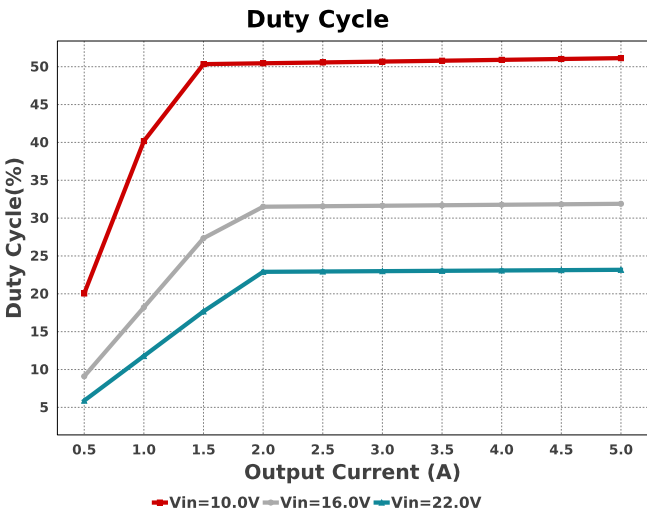
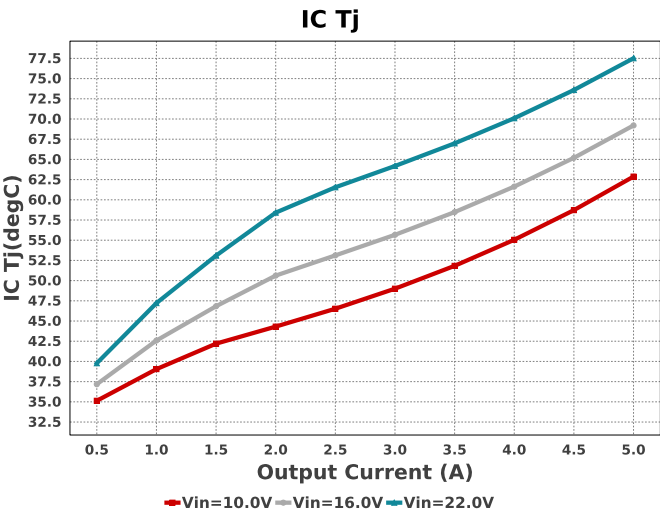
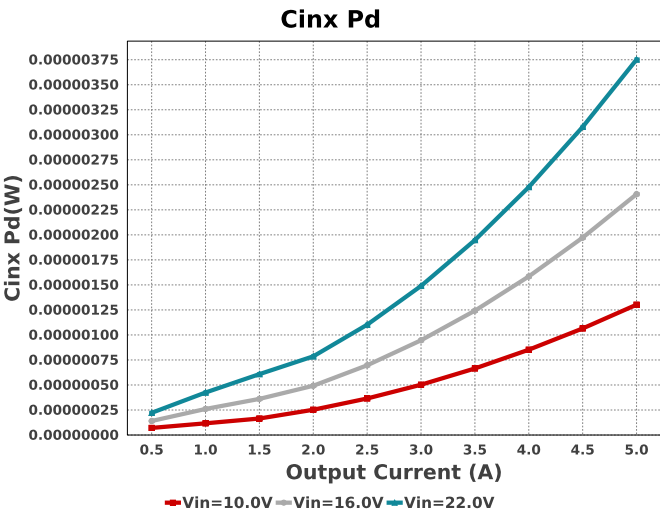


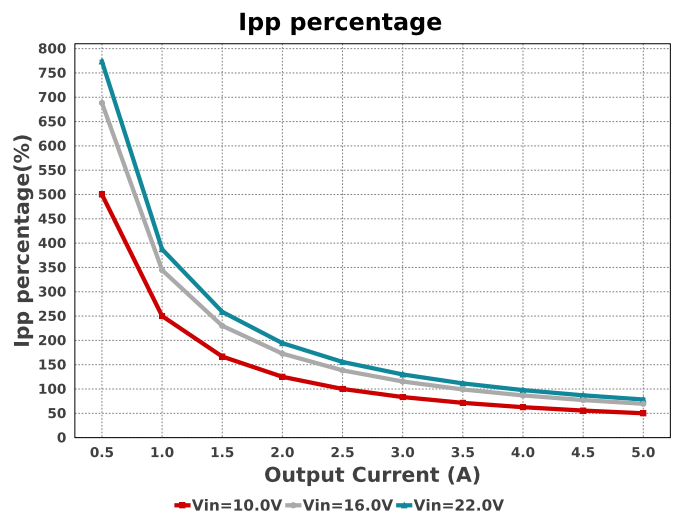
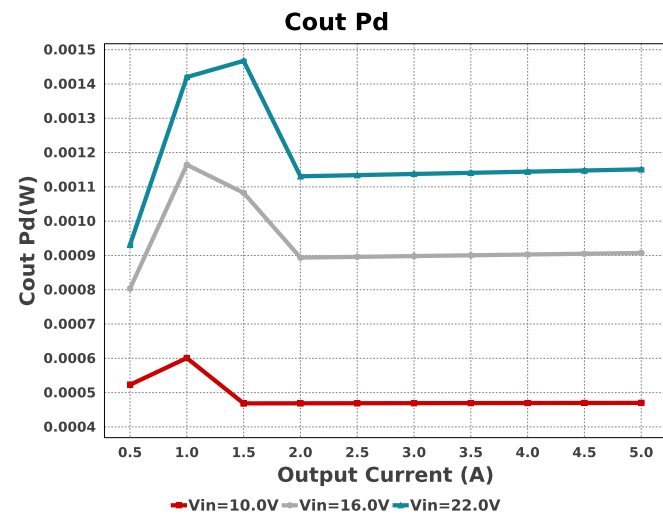
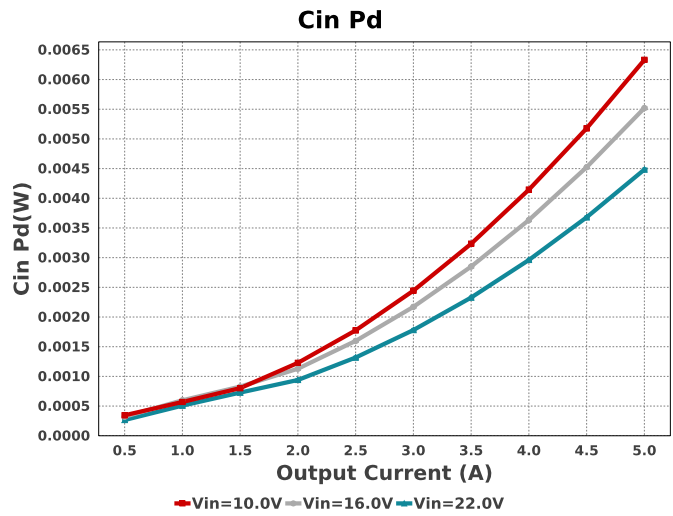
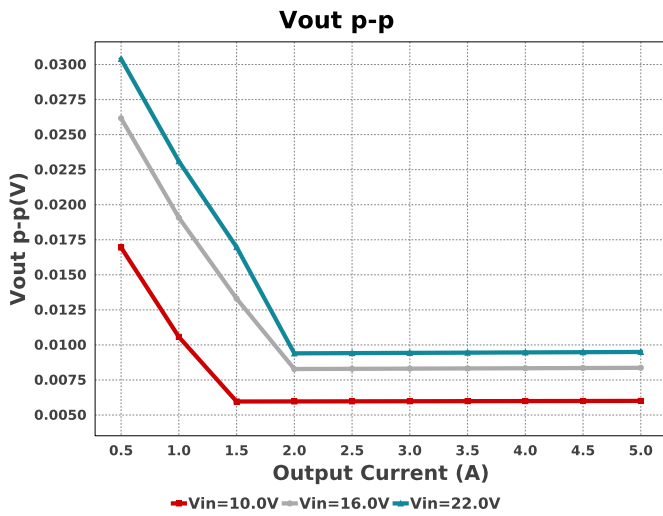
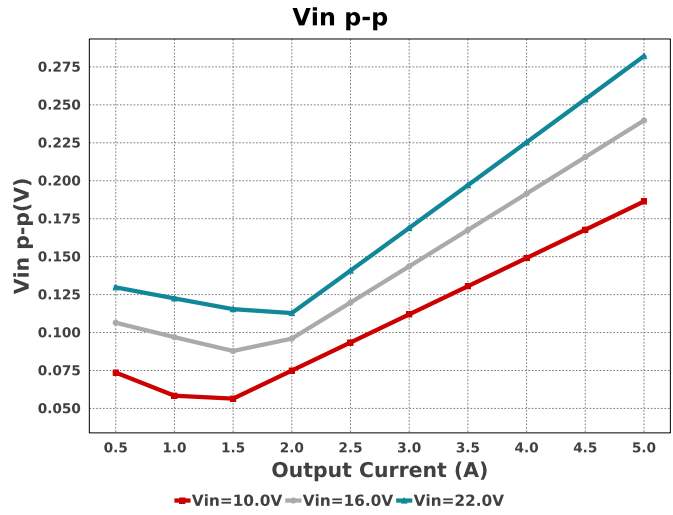
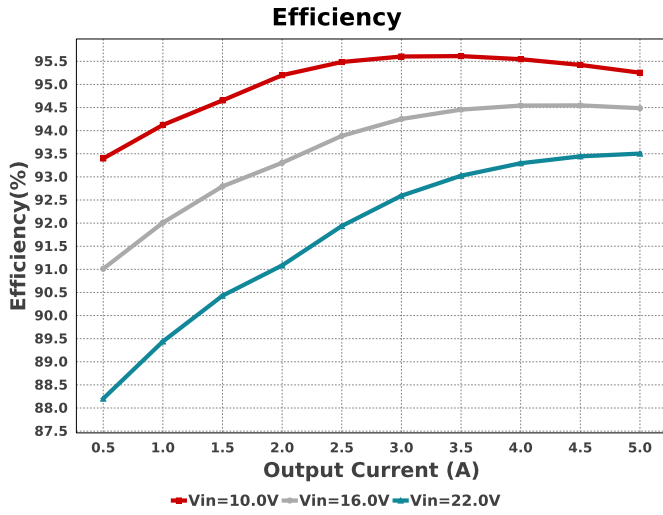
1. For given softstart time, the softstart capacitor selected in schematic is the nearest available capacitor to the calculated value.Recommend to double check based on datasheet soft-start formula.

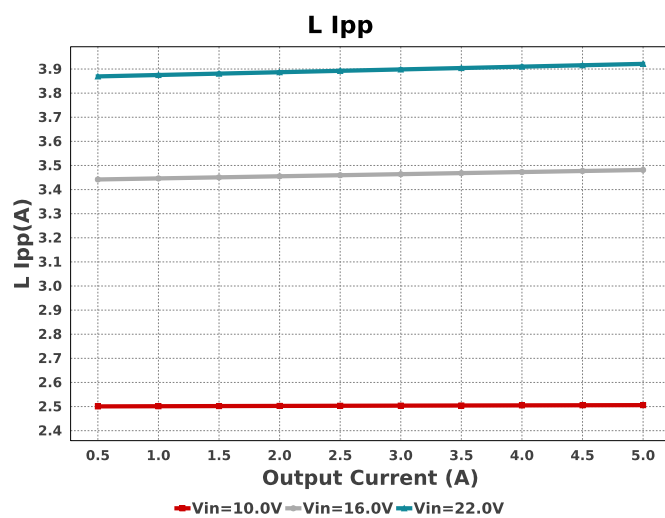
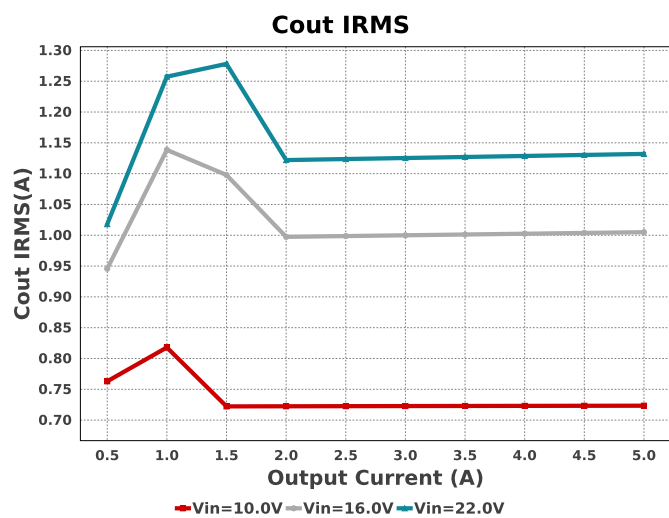
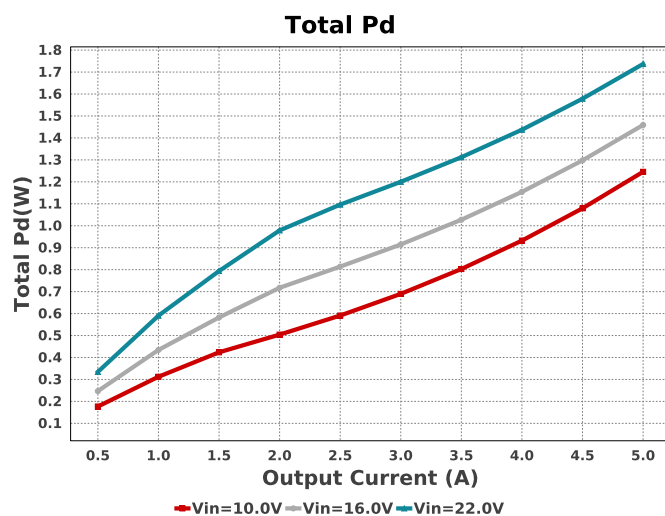
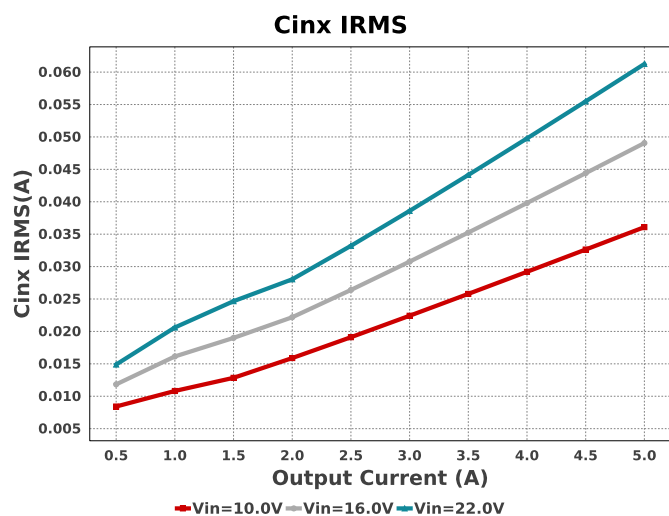
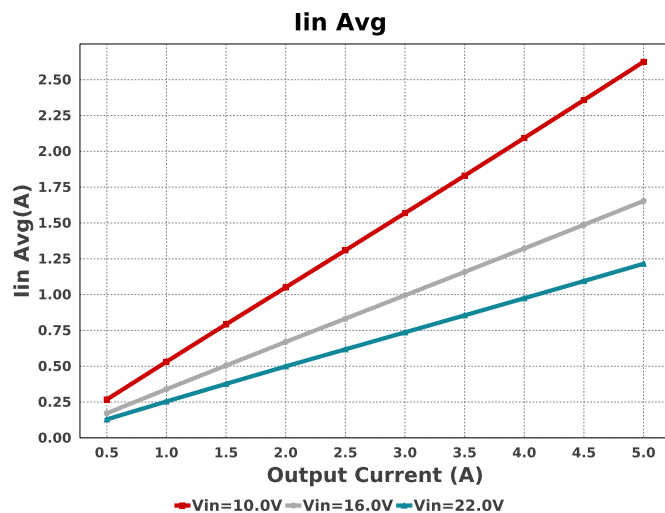
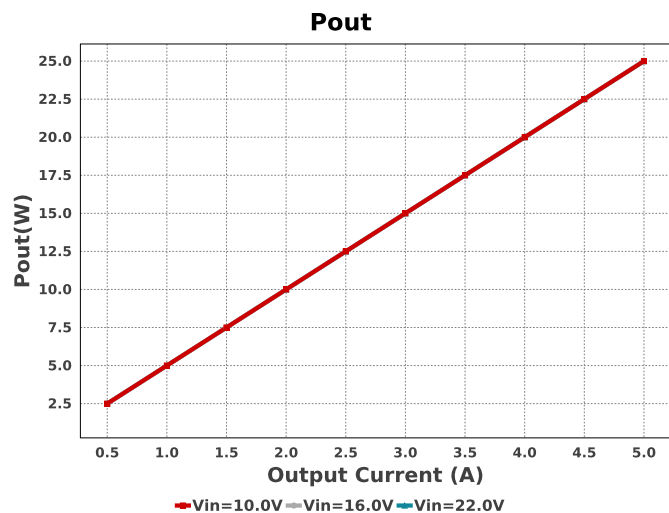
Electrical BOM

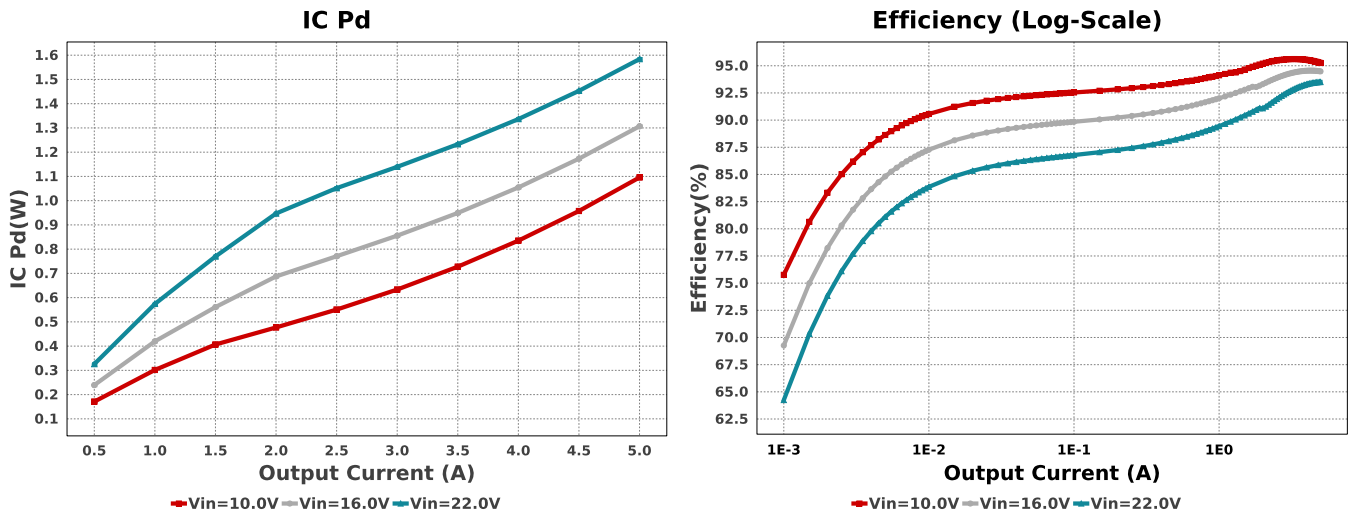
Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Cboot	Taiyo Yuden	EMK107B7104KA-T Series= X7R	Cap= 100.0 nF ESR= 1.0 mOhm VDC= 16.0 V IRMS= 0.0 A	1	\$0.01	 0603 5 mm ²
Cff	Kemet	C0603C220K4GACTU Series= C0G/NP0	Cap= 22.0 pF VDC= 16.0 V IRMS= 0.0 A	1	\$0.01	 0603 5 mm ²
Cin	TDK	C3216X5R1H106K160AB Series= X5R	Cap= 10.0 uF ESR= 1.0 mOhm VDC= 50.0 V IRMS= 4.9 A	1	\$0.24	 1206_180 11 mm ²
Cinx	MuRata	GRM21BR71H104KA01L Series= X7R	Cap= 100.0 nF ESR= 1.0 mOhm VDC= 50.0 V IRMS= 3.85 A	1	\$0.03	 0805 7 mm ²
Cout	MuRata	GRM31CR71A226KE15L Series= X7R	Cap= 22.0 uF ESR= 3.593 mOhm VDC= 10.0 V IRMS= 3.5332 A	4	\$0.12	 1206_190 11 mm ²
Cvcc	Kemet	C0603C105Z8VACTU Series= Y5V	Cap= 1.0 uF ESR= 1.0 mOhm VDC= 10.0 V IRMS= 0.0 A	1	\$0.01	 0603 5 mm ²
L1	Coilcraft	XAL6030-102MEB	L= 1.0 uH 5.6 mOhm	1	\$0.65	 XAL6030 72 mm ²
Rfbb	Vishay-Dale	CRCW040220K0FKED Series= CRCW..e3	Res= 20.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
Rfbt	Vishay-Dale	CRCW0402147KFKED Series= CRCW..e3	Res= 147.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²

Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Rpg	Vishay-Dale	CRCW0603100KFKEA Series= CRCW..e3	Res= 100.0 kOhm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	0603 5 mm ²
U1	Texas Instruments	TPS51385RJNR	Switcher	1	\$0.32	RJN0012A-MFG 12 mm ²









Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	2.118 A	Capacitor	Input capacitor RMS ripple current
2.	Cin Pd	4.484 mW	Capacitor	Input capacitor power dissipation
3.	Cinx IRMS	61.252 mA	Capacitor	Bulk capacitor RMS ripple current
4.	Cinx Pd	3.752 μ W	Capacitor	Bulk capacitor power dissipation
5.	Cout IRMS	1.132 A	Capacitor	Output capacitor RMS ripple current
6.	Cout Pd	1.151 mW	Capacitor	Output capacitor power dissipation
7.	IC Ipk	6.961 A	IC	Peak switch current in IC
8.	IC Pd	1.584 W	IC	IC power dissipation
9.	IC Tj	77.518 degC	IC	IC junction temperature
10.	IC Tolerance	50.0 mV	IC	IC Feedback Tolerance
11.	ICThetaJA Effective	30.0 degC/W	IC	Effective IC Junction-to-Ambient Thermal Resistance
12.	Iin Avg	1.215 A	IC	Average input current
13.	Ipp percentage	78.428 %	Inductor	Inductor ripple current percentage (with respect to average inductor current)
14.	L Ipp	3.921 A	Inductor	Peak-to-peak inductor ripple current
15.	L Pd	147.18 mW	Inductor	Inductor power dissipation
16.	Cin Pd	4.484 mW	Power	Input capacitor power dissipation
17.	Cinx Pd	3.752 μ W	Power	Bulk capacitor power dissipation
18.	Cout Pd	1.151 mW	Power	Output capacitor power dissipation
19.	IC Pd	1.584 W	Power	IC power dissipation
20.	L Pd	147.18 mW	Power	Inductor power dissipation
21.	Total Pd	1.737 W	Power	Total Power Dissipation
22.	BOM Count	14	System	Total Design BOM count
23.	Duty Cycle	23.17 %	System Information	Duty cycle
24.	Efficiency	93.504 %	System Information	Steady state efficiency
25.	FootPrint	170.0 mm ²	System Information	Total Foot Print Area of BOM components
26.	Frequency	996.153 kHz	System Information	Switching frequency
27.	Iout	5.0 A	System Information	Iout operating point
28.	Mode	CCM	System Information	Conduction Mode
29.	Pout	25.0 W	System Information	Total output power
30.	Total BOM	\$1.78	System Information	Total BOM Cost
31.	Vin	22.0 V	System Information	Vin operating point
32.	Vin p-p	282.108 mV	System Information	Peak-to-peak input voltage
33.	Vout	5.0 V	System Information	Operational Output Voltage
34.	Vout Actual	5.01 V	System Information	Vout Actual calculated based on selected voltage divider resistors
35.	Vout Tolerance	10.26 %	System Information	Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable
36.	Vout p-p	9.498 mV	System Information	Peak-to-peak output ripple voltage

#	Name	Value	Category	Description
37.	SoftStart Time Actual	0.0 s		Softstart Time (Calculated)

Design Inputs

Name	Value	Description
Iout	5.0	Maximum Output Current
VinMax	22.0	Maximum input voltage
VinMin	10.0	Minimum input voltage
Vout	5.0	Output Voltage
base_pn	TPS51385	Base Product Number
source	DC	Input Source Type
Ta	30.0	Ambient temperature

WEBENCH® Assembly

Component Testing

Some published data on components in datasheets such as Capacitor ESR and Inductor DC resistance is based on conservative values that will guarantee that the components always exceed the specification. For design purposes it is usually better to work with typical values. Since this data is not always available it is a good practice to measure the Capacitance and ESR values of C_{in} and C_{out} , and the inductance and DC resistance of $L1$ before assembly of the board. Any large discrepancies in values should be electrically simulated in WEBENCH to check for instabilities and thermally simulated in WebTHERM to make sure critical temperatures are not exceeded.

Soldering Component to Board

If board assembly is done in house it is best to tack down one terminal of a component on the board then solder the other terminal. For surface mount parts with large tabs, such as the DPAK, the tab on the back of the package should be pre-tinned with solder, then tacked into place by one of the pins. To solder the tab down to the board place the iron down on the board while resting against the tab, heating both surfaces simultaneously. Apply light pressure to the top of the plastic case until the solder flows around the part and the part is flush with the PCB. If the solder is not flowing around the board you may need a higher wattage iron (generally 25W to 30W is enough).

Initial Startup of Circuit

It is best to initially power up the board by setting the input supply voltage to the lowest operating input voltage 10.0V and set the input supply's current limit to zero. With the input supply off connect up the input supply to V_{in} and GND. Connect a digital volt meter and a load if needed to set the minimum load of the design from V_{out} and GND. Turn on the input supply and slowly turn up the current limit on the input supply. If the voltage starts to rise on the input supply continue increasing the input supply current limit while watching the output voltage. If the current increases on the input supply, but the voltage remains near zero, then there may be a short or a component misplaced on the board. Power down the board and visually inspect for solder bridges and recheck the diode and capacitor polarities. Once the power supply circuit is operational then more extensive testing may include full load testing, transient load and line tests to compare with simulation results.

Load Testing

The setup is the same as the initial startup, except that an additional digital voltmeter is connected between V_{in} and GND, a load is connected between V_{out} and GND and a current meter is connected in series between V_{out} and the load. The load must be able to handle at least rated output power + 50% (7.5 watts for this design). Ideally the load is supplied in the form of a variable load test unit. It can also be done in the form of suitably large power resistors. When using an oscilloscope to measure waveforms on the prototype board, the ground leads of the oscilloscope probes should be as short as possible and the area of the loop formed by the ground lead should be kept to a minimum. This will help reduce ground lead inductance and eliminate EMI noise that is not actually present in the circuit.



Design Assistance

1. Master key : C6AE7176C9723757[v1]
2. **TPS51385** Product Folder : <https://www.ti.com/product/TPS51385> : contains the data sheet and other resources.

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